ESP-WROOM-02 Datasheet



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About This Guide

This document provides introduction to the specifications of ESP-WROOM-02 hardware.

Release Notes

Date	Version	Release notes
2015.12	V0.5	First release.
2016.01	V0.6	Updated Section 3.2.2.
2016.02	V0.7	Added Appendix—Notices.Updated Chapter 1.
2016.04	V0.8	Updated the flash size and PAD (bottom) size.
2016.06	V0.9	Updated the flash size.
2016.06	V1.0	Added Appendix—Notices—B.5.Updated Figure 2-1.
2016.08	V1.1	Updated the operating temperature range.
2016.11	V1.2	Added Appendix—Learning Resources.Added "ESP-WROOM-02 Peripheral Schematics" in Chapter 5.
2016.11	V2.0	Added Section 4.8 "Electrostatic Discharge".Updated Figure 5-1. ESP-WROOM-02 Schematics.
2016.12	V2.1	 Changed the minimum working voltage from 3.0V to 2.5V. Changed the power consumption during Deep-sleep from 10 μA to 20 μA.
2017.02	V2.2	Updated Section 3.3.
2017.04	V2.3	 Added the module's dimensional tolerance; Changed the input impedance value in Table 4-4 and 4-5 from 50Ω to 39+j6 Ω; Added Figure 4-1 Reflow Profile.
2017.09	V2.4	 Added <u>Documentation Change Notification</u> and the official link for downloading <u>Product Certificates</u>; Updated the supply voltage to 2.7 V ~ 3.6 V; Updated Figure 2-1 ESP-WROOM-02 Pin Layout and added a note to it; Updated Chapter 4: Collated electrical-characteristics-related data into Table 4-1; collated Wi-Fi-radio-related data into Table 4-2 and updated the output power parameters; Updated Chapter 5 Schematics and added a note; Added Chapter 6 Dimensions. Deleted Appendix B—Notices.
2017.10	V2.5	Updated the note to ESP-WROOM-02 Peripheral Schematics in Chapter 5.

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Certification

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1.

Overview

Espressif provides the SMD module—ESP-WROOM-02 that integrates ESP8266EX. The module has been adjusted to get the best RF performance. We recommend using ESP-WROOM-02 for tests or for further development.

Note:

For more information on ESP8266EX, please refer to ESP8266EX Datasheet.

The module size is (18 ± 0.2) mm x (20 ± 0.2) mm x (3 ± 0.15) mm. The type of flash used on this module is an SPI flash with a package size of SOP 8-150 mil. The gain of the on-board PCB antenna is 2 dBi.



Figure 1-1. ESP-WROOM-02 Module

Table 1-1. ESP-WROOM-02 Specifications

Categories	Items	Specifications
	RF certification	FCC/CE/TELEC/KCC/SRRC/IC/NCC
Wi-Fi	Wi-Fi protocols	802.11 b/g/n
	Frequency range	2.4 GHz ~ 2.5 GHz (2400M ~ 2483.5M)
	Peripheral interface	UART/HSPI/I2C/I2S/IR Remote Control
	T diplicial interface	GPIO/PWM
	Operating voltage	2.7V ~ 3.6V
	Operating current	Average: 80 mA
Hardware	Minimum current delivered by power supply	500 mA
	Operating temperature range	-40°C ~ 85°C



Categories	Items	Specifications
	Storage temperature	-40°C ~ 85°C
	Package size	(18±0.2) mm x (20±0.2) mm x (3±0.15) mm
	External interface	-
	Wi-Fi mode	Station/SoftAP/SoftAP + Station
	Security	WPA/WPA2
	Encryption	WEP/TKIP/AES
Software	Firmware upgrade	UART Download/OTA (via network)/Download and write firmware via host
	Software development	Supports Cloud Server Development/SDK for custom firmware development
	Network protocols	IPv4, TCP/UDP/HTTP/FTP
	User configuration	AT Instruction Set, Cloud Server, Android/iOS app

Note:

ESP-WROOM-02 with high temperature range option (-40 $^{\circ}$ C \sim 125 $^{\circ}$ C) is available for custom order.



2.

Pin Description

Figure 2-1 shows the pin distribution of the ESP-WROOM-02.

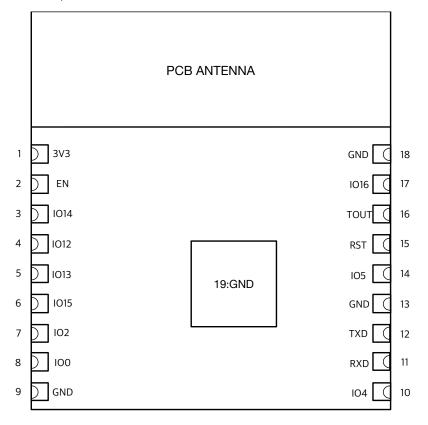


Figure 2-1. ESP-WROOM-02 Pin Layout

ESP-WROOM-02 has 18 pins. Please see the pin definitions in Table 2-1.

Table 2-1, ESP-WROOM-02 Pin Definitions

No.	Pin Name	Functional Description
		3.3V power supply (VDD)
1	3V3	Note:
•		It is recommended the maximum output current a power supply provides be of 500 mA or above.
2	EN	Chip enable pin. Active high.
3	IO14	GPIO14; HSPI_CLK
4	IO12	GPIO12; HSPI_MISO
5	IO13	GPIO13; HSPI_MOSI; UARTO_CTS



No.	Pin Name	Functional Description
6	IO15	GPIO15; MTDO; HSPICS; UARTO_RTS Pull down.
7	102	GPIO2; UART1_TXD Floating (internal pull-up) or pull up.
8	100	GPIO0UART download: pull down.Flash boot: floating or pull up.
9	GND	GND
10	104	GPIO4
11	RXD	UARTO_RXD, receive end in UART download; GPIO3
12	TXD	UART0_TXD, transmit end in UART download, floating or pull up; GPIO1
13	GND	GND
14	105	GPIO5
15	RST	Reset
16	TOUT	It can be used to test the power-supply voltage of VDD3P3 (Pin3 and Pin4) and the input power voltage of TOUT (Pin6). These two functions cannot be used simultaneously.
17	IO16	GPIO16; used for Deep-sleep wake-up when connected to RST pin.
18	GND	GND



Functional Description

3.1. MCU

ESP8266EX integrates the Tensilica L106 32-bit microcontroller (MCU) and ultra-low-power 16-bit RSIC. The CPU clock speed is 80 MHz and can reach a maximum value of 160 MHz. The system can readily run a Real-Time Operating System (RTOS). Currently, the Wi-Fi stack only takes up 20% of CPU time. The remaining CPU time (80% of total MIPS) can be used for user applications. The CPU can interface through:

- Programmable RAM/ROM interfaces (iBus) that connect to memory controller and can access the external flash.
- Data RAM interface (dBus) that connects to the memory controller.
- AHB interface that accesses the register.

3.2. Memory

3.2.1. Internal SRAM and ROM

ESP8266EX Wi-Fi SoC integrates the memory controller and memory units including ROM and SRAM. MCU can access the memory units through iBus, dBus, and AHB interfaces. All memory units can be accessed upon request. A memory arbiter determines the running sequence in the arrival order of requests.

According to our current version of SDK, the SRAM space available to users is assigned as follows:

- RAM size < 50 kB, that is, when ESP8266EX is working in Station mode and connects to the router, available space in the Heap + Data sector is around 50 kB.
- There is no programmable ROM in ESP8266EX, therefore, the user program must be stored in an external SPI flash.

3.2.2. SPI Flash

ESP8266EX supports SPI flash. Theoretically speaking, ESP8266EX can support an up-to-16-MB SPI flash.

ESP-WROOM-02 currently integrates a 2-MB SPI flash. ESP-WROOM-02 supports these SPI modes: Standard SPI, DIO (Dual I/O), DOUT (Dual Output), QIO (Quad I/O) and QOUT (Quad Output).

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3.3. Crystal Oscillator

ESP-WROOM-02 uses a 26-MHz crystal oscillator. The accuracy of the crystal oscillator should be ± 10 PPM.

When using the download tool, please select the right type of crystal oscillator. In circuit design, capacitors C1 and C2 which connect to the earth are added to the input and output terminals of the crystal oscillator respectively. The values of the two capacitors can be flexible, ranging from 6 pF to 22 pF, however, the specific capacitive values depend on further testing of, and adjustment to, the overall performance of the whole circuit. Normally, the capacitive values of C1 and C2 are within 10 pF for the 26-MHz crystal oscillator.

3.4. Interface Description

Table 3-1. Interface Description

Interface	Pin	Functional Description
HSPI	IO12 (MISO), IO13 (MOSI), IO14 (CLK), IO15 (CS)	Connects to SPI Flash, display screen, and MCU.
PWM	IO12 (R), IO15 (G),IO13 (B)	Currently the PWM interface has four channels, but users can extend it to eight channels. PWM interface can realize the control of LED lights, buzzers, relays, electronic machines, etc.
IR	IO14 (IR_T), IO5 (IR_R)	The functionality of the infrared remote control interface can be realized via software programming. The interface uses NEC coding, modulation, and demodulation. The frequency of the modulated carrier signal is 38 kHz.
ADC	TOUT	Tests the power supply voltage of VDD3P3 (Pin3 and Pin4) and the input power voltage of TOUT (Pin6). However, these two functions cannot be used simultaneously. This interface is typically used in sensors.
12C	IO14 (SCL), IO2 (SDA)	Connects to external sensors and display screens, etc.
UART	UARTO: TXD (U0TXD), RXD (U0RXD), IO15 (RTS), IO13 (CTS) UART1: IO2 (TXD)	Communicates with the UART device. Downloading: U0TXD + U0RXD or GPIO2 + U0RXD Communicating: (UARTO): U0TXD, U0RXD, MTDO (U0RTS), MTCK (U0CTS) Debugging: UART1_TXD (GPIO2) can be used to print debugging information. By default, UARTO will output some printed information when you power on ESP8266EX. If this issue influences some specific applications, users can exchange the inner pins of UART when initializing ESP8266EX, that is, exchange U0TXD and U0RXD with U0RTS and U0CTS. Users can connect MTDO and MTCK to the serial port of the external MCU to realize the communication.

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Interface	Pin	Functional Description
128	I2S input: IO12 (I2SI_DATA); IO13 (I2SI_BCK); IO14 (I2SI_WS); I2S output: IO15 (I2SO_BCK); IO3 (I2SO_DATA); IO2 (I2SO_WS).	Collects, processes and transmits audio data.



4. Electrical Characteristics

Note:

Unless otherwise specified, measurements are based on VDD = 3.3V, TA = $25\,^{\circ}$ C.

4.1. Electrical Characteristics

Table 4-1. Electrical Characteristics

Parameter	Symbol	Min	Тур	Max	Unit
Storage temperatue	-	-40	Normal	85	°C
Operating temperature	-	-40	20	85	°C
Maximum soldering temperature (Condition: IPC/JEDEC J-STD-020)	-	-	-	260	°C
Supply voltage	VDD	2.7	3.3	3.6	V
Input logic level low	V _{IL}	-0.3	-	0.25 VDD	V
Input logic level high	VIH	0.75 VDD	-	VDD + 0.3	V
Output logic level low	V _{OL}	-	-	0.1 VDD	V
Output logic level high	Voн	0.8 VDD	-	-	V

4.2. Wi-Fi Radio

Table 4-2. Wi-Fi Radio Characteristics

Description	Min	Тур	Max	Unit
Input frequency	2412	-	2484	MHz
Input reflection	-	-	-10	dB
	Output Po	wer		
PA output power at 72.2 Mbps	13	14	15	dBm
PA output power in 11b mode	19.5	20	20.5	dBm
	Sensitivi	ty		
CCK, 1 Mbps	-	-98	-	dBm
CCK, 11 Mbps	-	-91	-	dBm

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Description	Min	Тур	Max	Unit
6 Mbps (1/2 BPSK)	-	-93	-	dBm
54 Mbps (3/4 64-QAM)	-	-75	-	dBm
HT20, MCS7 (65 Mbps, 72.2 Mbps)	-	-72	-	dBm
A	Adjacent channe	l rejection		
OFDM, 6 Mbps	-	37	-	dB
OFDM, 54 Mbps	-	21	-	dB
HT20, MCS0	-	37	-	dB
HT20, MCS7	-	20	-	dB

4.3. Power Consumption

The following power consumption data were obtained from the tests with a 3.3V power supply and a voltage stabilizer, in 25°C ambient temperature. All data are based on 50% duty cycle in continuous transmission mode.

Table 4-3. Power Consumption

Modes	Min	Тур	Max	Unit
Tx 802.11b, CCK 11 Mbps, Pout = +17 dBm	-	170	-	mA
Tx 802.11g, OFDM 54 Mbps, Pout = +15 dBm	-	140	-	mA
Tx 802.11n, MCS7, Pout = +13 dBm	-	120	-	mA
Rx 802.11b, 1024 bytes packet length , -80 dBm	-	50	-	mA
Rx 802.11g, 1024 bytes packet length , -70 dBm	-	56	-	mA
Rx 802.11n, 1024 bytes packet length , -65 dBm	-	56	-	mA
Modem-sleep①	-	15	-	mA
Light-sleep②	-	0.9	-	mA
Deep-sleep③	-	20	-	μΑ
Power Off	-	0.5	-	μΑ



Notes:

- ① Modem-sleep is used when such applications as PWM or I2S require the CPU to be working. In cases where Wi-Fi connectivity is maintained and data transmission is not required, the Wi-Fi Modem circuit can be shut down to save power, according to 802.11 standards (such as U-APSD). For example, in DTIM3, when ESP8266EX sleeps for 300 ms and wakes up for 3 ms to receive Beacon packages from AP, the overall average current consumption is about 15 mA.
- ② Light-sleep is used for applications whose CPU may be suspended, such as Wi-Fi switch. In cases where Wi-Fi connectivity is maintained and data transmission is not required, Wi-Fi Modem circuit and CPU can be shut down to save power, according to 802.11 standards (such as U-APSD). For example, in DTIM3, when ESP8266EX sleeps for 300 ms and wakes up for 3 ms to receive Beacon packages from AP, the overall average current consumption is about 0.9 mA.
- ③ **Deep-sleep** is for applications that do not require Wi-Fi connectivity and only transmit data over long time lags, e.g., a temperature sensor that measures temperature every 100s. For example, when ESP8266EX sleeps for 300s then wakes up to connect to AP (taking about 0.3 ~ 1s), the overall average current consumption is far less than 1 mA. The current consumption of 20 μA was obtained at the voltage of 2.5V.

4.4. Reflow Profile

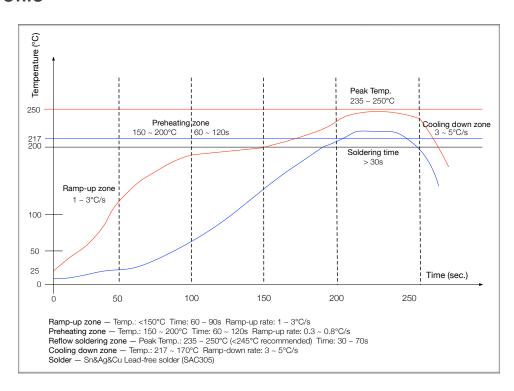


Figure 4-1. ESP-WROOM-02 Reflow Profile

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4.5. Electrostatic Discharge

Table 4-4. Electrostatic Discharge Parameters

Name	Symbol	Reference	Level	Max	Unit
Electrostatic Discharge (Human - Body Model)	VESD (HBM)	Temperature: 23 ± 5°C Based on ANSI/ESDA/JEDEC JS - 001 - 2014	2	2000	
Electrostatic Discharge	VESD	Temperature: 23 ± 5°C	G2	500	-V
(Charged - Device Model)	(CDM)	Based on JEDEC EIA/JESD22 - C101F	02	500	

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Schematics

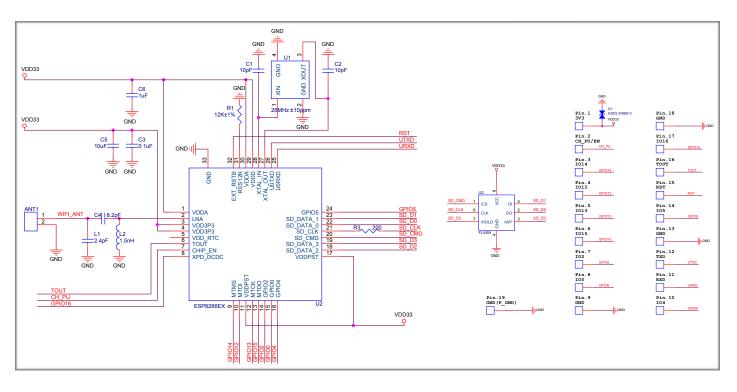


Figure 5-1. ESP-WROOM-02 Schematics



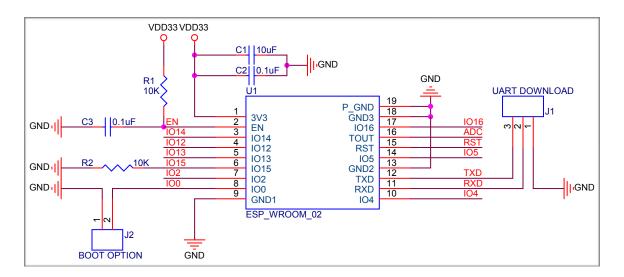


Figure 5-2. ESP-WROOM-02 Peripheral Schematics

Note:

Soldering Pad 19 to the Ground of the base board is not necessary for a satisfactory thermal performance. If users do want to solder it, they need to ensure that the correct quantity of soldering paste is applied.



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Dimensions

6. Dimensions

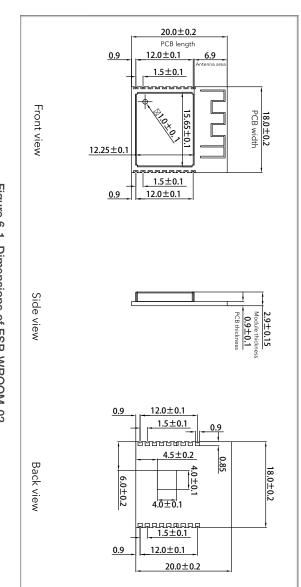


Figure 6-1. Dimensions of ESP-WROOM-02



A.

Appendix — Learning Resources

A.1. Must-Read Documents

ESP8266 Quick Start Guide

Description: This document is a quick user guide to getting started with ESP8266. It includes an introduction to the ESP-LAUNCHER, how to download firmware on to the board and run it, how to compile the AT application, structure and the debugging method of RTOS SDK. Basic documentation and other related resources for the ESP8266 are also provided.

• ESP8266 SDK Getting Started Guide

Description: This document takes ESP-LAUNCHER and ESP-WROOM-02 as examples to introduce how to use ESP8266 SDK. The contents include preparations before compilation, SDK compilation and firmware download.

ESP-WROOM-02 PCB Design and Module Placement Guide

Description: The ESP-WROOM-02 module is designed to be soldered to a host PCB. This document compares six different placements of the antenna on a host board and provides notes on designing PCB.

• ESP8266 Hardware Resources

Description: This zip package includes manufacturing specifications of the ESP8266 board and the modules, manufacturing BOM and schematics.

ESP8266 AT Command Examples

Description: This document introduces some specific examples of using Espressif AT commands, including single connection as a TCP Client, UDP transmission and transparent transmission, and multiple connection as a TCP server.

• ESP8266 AT Instruction Set

Description: This document provides lists of AT commands based on ESP8266_NONOS_SDK, including user-defined AT commands, basic AT commands, Wi-Fi AT commands and TCP/IP-related AT commands. It also introduces the downloading of AT firmware into flash.

TCP/UDP UART Passthrough Test Demonstration

Description: This guide is intended to help users run a TCP & UDP passthrough test on the ESP8266 IoT platform.

FAQ



A.2. Must-Have Resources

• ESP8266 SDKs

Description: This website page provides links to the latest version of ESP8266 SDK and the older ones.

• ESP8266 Tools

Description: This website page provides links to the ESP8266 flash download tools and ESP8266 performance evaluation tools.

- ESP8266 App
- ESP8266 Certification and Test Guide
- ESP8266 BBS
- ESP8266 Resources



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